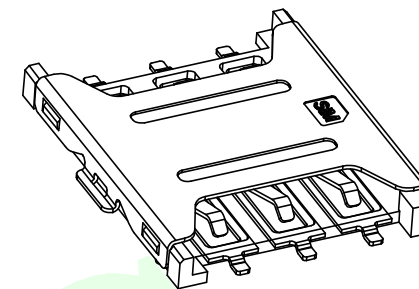


RoHS Compliant



SPECIFICATION

MATERIAL:

INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,UL 94V-0.

CONTACT: C5210

SHELL: SUS

PLATING:

CONTACT: PLATED 50U" NI OVERALL CONTACT ALL AU 1U

SHELL: PLATED 50U" NI OVERALL,PAD AU 1U

ELECTRICAL:

CURRENT RATING: 0.5MA AC/DC MAX

VOLTAGE RATING: 125V AC/DC

VOLTAGE RATING: 125V AC/DC
AMBIENT TEMPERATURE RANGE: -20°C~+60°C

STORAGE TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +70^{\circ}\text{C}$

STORAGE TEMPERATURE RANGE: -40 C/°F.
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.

CONTACT RESISTANCE: 100MΩ MAX.

INSULATION RESISTANCE: 1000MΩMIN./500VDC

REFLOW PEAK TEMP: 260°C ±5°C, 3~5 S

MATING CYCLES: 5,000 INSERTIONS MIN

PIN#	Name
C1	VCC 供电电压
C2	RST 重置
C3	CLK 时钟
C5	GND 接地
C6	VPP 程序电压
C7	I/O 输入输出

The diagram illustrates the breakdown of the marking code **LCK-NANO-1151-P6 H135-Y L G** into its constituent parts:

- LCK**: 连晟欣 (Lian Sheng Xin)
- NANO**: 产品类别 (Product Category)
- 1151**: MS: MINI SIM; SIM: MICRO SIM; NANO: NANO SIM
- P6**: 产品PIN位 (Product PIN Position); P6: 6PIN
- H135**: 产品高度 (Product Height); H135: 1.35MM
- Y**: 有柱 (With Pillar)
- L**: 无柱 (Without Pillar)
- G**: 电镀规格 (Electroplating Specification); G: gold flash; G1: 1U; G3: 3U (以此类推)
- 包装方式**: 包装方式 (Packaging Method); L: 圆盘 (Disk)
- 品流水料号识别码**: 有柱无柱 (With Pillar/Without Pillar); Y: 有柱 (With Pillar); W: 无柱 (Without Pillar)

MEASURE POINT:

QUADRANT POINT

QUADRANT POINT	
EMERSON POINT	

TANGERCY POINT INTERSECTION POINT 

UNLESS OTHERWISE

UNLESS OTHERWISE
SPECIFIED TOLERANCE

SPECIFIED, TOLERANCE:

X.	± 0.25
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X.x	±0.20
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XXX	± 0.20
X:xx	± 0.15

$\lambda_{.xx}$	± 0.15
ANGULAR	$\pm 3^\circ$

ANGULAR	$\pm 3'$
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 联晟欣连接器（深圳）有限公司 Lianshengxin Connector (Shenzhen) Co., Ltd			
DESIGN	Andy	DATE	2014.12.24
CHECKED		DATE	
APPROVED		DATE	
TITLE: 6Pin 1.35H PUSH PULL Nano SIM CARD CONN.			
PART NO: LCK-NANO-1151-P6H135YLG		REV: 04	SCALE: 1:1
DRAWING NO: 1020221390		SIZE: A4	SHEET: 1/1